

PLENARY / DETECTOR TECHNOLOGIES

From ECFA Detector Roadmap to DRD Collaborations and beyond

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23-27 JUNE 2025 Lido di Venezia



ECFA Detector Roadmap

The community should define a <mark>global detector R&D roadmap</mark> that should be used to <mark>support proposals at the European and national levels</mark>.



European Strat

for Particle Phy

ECFA detector roadmap released in 2021 with <u>full document (200 pages)</u> and <u>synopsis</u> (~10 pages) based on a **community-driven effort** with many community meetings

The full document can be referenced as **DOI: 10.17181/CERN.XDPL.W2EX**

Document contains:

- Overview of **future facilities** (EIC, ILC, CLIC, FCC-ee/hh, Muon collider) or major **upgrades** (ALICE, Belle-II, LHC-b,...) and their **timelines**
- Ten "General Strategic Recommendations" (GSRs) see next slide....
- Nine Technology domains with Task Forces (TF) areas:
 - The most urgent R&D topics in each domain, identified as Detector R&D Themes (DRDTs)



General Strategic Recommendations

Formulated in the ECFA Detector Roadmap as ten "action items"

- International coordination and organization of R&D activities (GSR 4)
- Establish long-term strategic **funding programs** (GSR 6) → ongoing
- Support "Blue-sky" R&D (GSR 7) → ongoing

DRD Collaborations

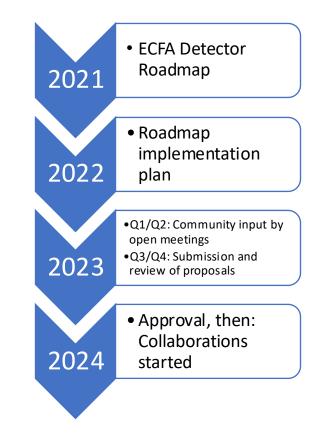
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- Supporting **R&D facilities**: test beams, large-scale prototyping, irradiation (GSR 1)
- Engineering support for detector R&D (GSR 2)
- Specific **software** for instrumentation (GSR 3)
- Distributed R&D activities with **centralized facilities** (GSR 5)
- All topics still valid and highly relevant • Attract, nurture, recognize, and sustain the careers of R&D experts (GSR 8)
- Establish and maintain **Industrial partnerships** (GSR 9)
- Support **Open Science** (GSR 10)



From Roadmap to DRD collaborations

- *Roadmap implementation plan* defined that CERN will host the DRD collaborations
 - Approved by CERN SPC and Council in fall 2022 (<u>CERN/SPC/1190 ; CERN/3679</u>)
 - New committee created as reviewing body, the DRDC at the same level as LHCC, SPSC and others
- Most of the chapter's convenors ("Task Forces") from ECFA Roadmap process became part of *Proposal Writing Teams* for new DRD collaborations
 - Collected input from the communities in open meetings happening in the first half of 2023
- Approval of DRD collaborations by CERN Research Board:
 - DRD1,2 4 & 6 in December 2023
 - DRD3, 5 and 7 in June 2024
 - DRD 8 in December 2024





The DRD Collaborations

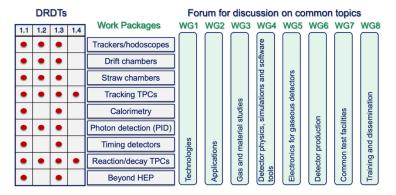
Eight DRD collaborations have been approved for an initial period of 3 years (extendable) with different histories and "maturity":

- Based on previous R&D collaborations:
 - **DRD1: Gaseous detectors** (based on RD51): 161 institutes, 700++ people
 - DRD3: Semiconductor Detectors (previously RD42, RD50): 145 institutions / 700++ people
 - **DRD6: Calorimetry** (CALICE, other proto-experiment collabs.): 135 institutes
- Completely new: (community building, building trust, and finding benefit of being "CERN hosted")
 - DRD2: Liquid Detectors: 86 institutes, 205 members
 - DRD4: Photodetectors & PID: 74 institutes
 - DRD5: Quantum Sensors and emerging technologies: 112 involved groups
- Transversal activities: no service provider, but with genuine R&D interest (TF9 → ECFA Training Panel)
 - DRD7: Electronics: 67 Institutes
 - DRD8: Mechanics & Integration: 38 institutes



All DRDs in similar shape

- Approved for an **initial period of three years** based on work programs in the proposals
 - Annual review by the DRDC committee
- Collaborations are organized in
 - Working Groups: (WG) serving as the backbone of R&D
 - Work Packages: resource-loaded; will reflect the DRDTs
- All administrative positions (WP/WG convenors) filled, but most work started in working groups so far
- CERN Greybook entries exist; Users can be registered to DRD collaborations
- Websites for all (but DRD6) exist following the schema https://drd1.web.cern.ch
- Certain DRD collaborations ask for a fixed **yearly membership fee** (Common Fund), targeting common projects, but also blue-sky R&D projects (GSR 7)
 - However, DRD collaborations are not funding proposals!
 - MoU's with resource requests to be signed by funding agencies \rightarrow ongoing (GSR 6)



DRD1 input proposal #229



DRDs should cover Strategic R&D

Strategic R&D bridges the gap between the idea ("blue sky research", low TRLs) and the **deployment and use in a HEP experiment** (TRL 8-9)

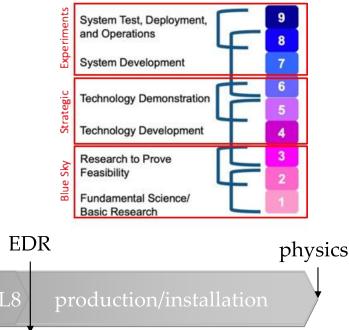
Covers the **development and maturing of technologies**, e.g.

- Iterating through different options
- Improving radiation hardness

٠

• Scaling up challenges: detector area, number of channels, layers,...

"NASA" TRL levels:



experim	ent LoI	exper		iding approval	EDR	physics
"blue sky" R&D	TRL3	DRD	TRL6	engineering (TRL	.8 production/in	nstallation
game changers new technologies new paradigms	explore	ature concepts performance technology o	phase	final devices and specific to exper	5	Didier Contardo
26 June 2025		T. Bergauer	ESPP Open Sym	posium DRD Collaborations		-

TDR

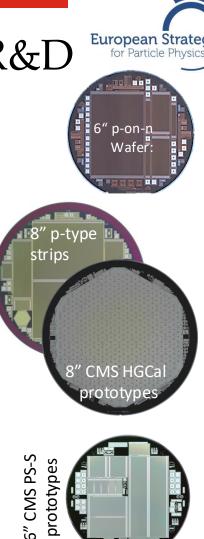
Example of the need for strategic R&D

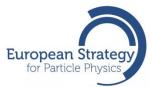
There have been several efforts to establish European semiconductor companies as an alternative to Hamamatsu for large area planar sensors in the past:

- For "Phase-0" : Several INFN institutes worked with STMicroelectronics for p-on-n strip sensors for CMS Outer Tracker → Influenced decision for "full silicon tracker" in CMS
- For "Phase-II" Upgrades: 9-year long R&D with **Infineon**: First large strip sensors on 8-inch wafers, first hexagonal pad sensors
 - → Pushed HPK into developing 8" process now being used for CMS HGCal

Both projects stopped before becoming a success.

Several more wafer runs would have been necessary to mature the technology and to transfer it to series production \rightarrow lack of funding





Work Program and Scientific Highlights of the DRD collaborations

Eight densely packed slides

ECFA Detector Panel #157

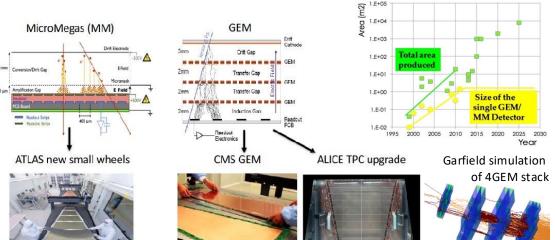
Parallel Talk: M. Titov

DRD1: Gaseous Detectors

- **Long road** from MWPC \rightarrow Drift Chamber \rightarrow Time ٠ Projection Chamber (TPC) \rightarrow Micro-Pattern Gas Detectors (MPGD)
- Primary choice for large-area coverage with low material ٠ budget & dE/dx measurement (TPC, Drift chamber) & ToF functionality (MRPC, PICOSEC)
 - Systems developed for LHC experiments led to unprecedentedly large systems, mostly based on MPGDs
 - Most FCC-ee detector concepts use gas detectors for the main tracker and muon systems

Working Topics Highlights:

- High rates: reduce ion back drift
- Reduce aging and radiation hardness
- Fast Timing: Multi-Gap RPCs: achieved ~60ps time resolution (ALICE TOF Detector, Z.Liu, NIM A927 (2019) 396), Micromegas with timing (PICOSEC concept): 25ps
- Eco-friendly gas mixtures: with lower Global Warming Potential ٠ (GWP): 92% of CERN emissions related to LHC experiments
- Common readout system SRS for MPGDs, Beyond HEP ٠

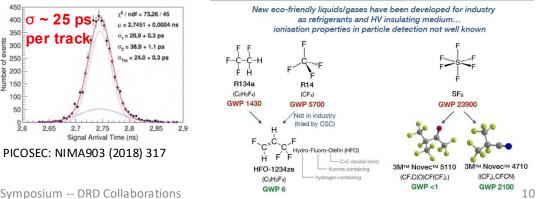


Possible alternatives to GHG gases

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26 June 2025

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200

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25 ps

per track

2 65 2.7

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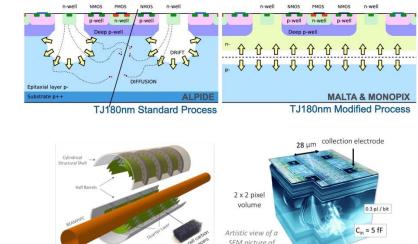
Parallel Talk: D. Bortoletto

DRD3: Semiconductor Detectors

Higgs factory experiments: low mass, high precision **vertex** detectors: $(\sim 0.1\% X_0)$ /layer, 3µm single-hit resolution; ToF wrappers around tracker for PID: ~O(20)ps

Research Topics in DRD3:

- CMOS Monolithic Active Pixel sensors (MAPS):
 - Sensor development becomes mixed-mode chip development,
 - Challenges: access to foundries, engineering workforce
 - Most advanced developments (ALICE) not strongly involved in DRD3, though
- 4D Tracking/ToF: Timing using Low Gain Avalanche Detectors (LGAD)
 - Timing performance ~ 25 ps, but radiation hardness limited
- Extreme Radiation hardness: 3D sensors, wide bandgap sensors, e.g. SiC, GaN and Diamond
 - Activities from RD50 heritage, and for longer-term R&D towards FCC-hh
- Interconnection technologies



Different LGAD technologies: Trench Isolation LGAD AC-LGAD Invers LGAD Deep Junction LGAD Front segmented readour ront: segmented readout ditional main isolation gain lave Gain layer locate Back: gain laver deep under front electrode: menches isolation (HD-IGA



_ (MIP) ≈ 1300 e 🗢 V ≈ 40r

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G. Gaudio

DRD6: Calorimetry #108

Calorimeters need many technologies from other DRDs

- Sandwich calorimeters with fully embedded electronics and CMOS MAPS, SiPM or gas-detector readout
- Liquified Noble Gas: ALLEGRO detector concept (lAr with lead)
- **Optical calorimeters**, homogeneous EM with scintillators (BGO, LYSO,..) and SiPM or MCP-PMT readout
- Electronics and DAQ: sophisticated FE chip developments

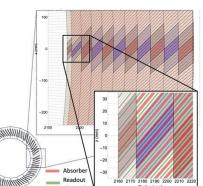
Overarching goals:

- **Dual Readout Calorimetry** to mitigate different response of EM and hadronic showers
- Particle Flow to improve jet energy resolution

Challenges:

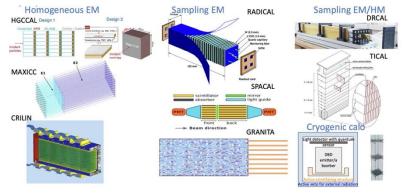
- High pixelisation, 4π hermetic -> little room for services
- Large and challenging prototype setups, even in early stages. What can be done with simulations?





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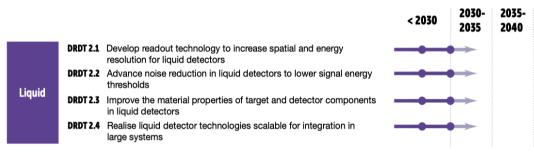
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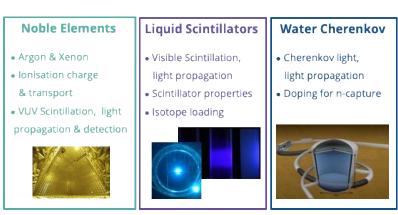


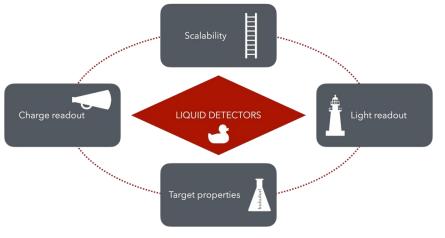
Parallel Talk: I. Gil-Botella



- Covers Dark Matter, Neutrino and 0vßß experiments, both accelerator and non-accelerator-based
- Underground Dark Matter Experiments small and rare signals
- R&D for multi-ton scale noble liquids:
 - Target doping and purification
 - Detector components radiopurity and background mitigation
 - Lower energy thresholds
 - Efficient and fast cryogenic photodetectors → Increase of light yield and background reduction







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Parallel Talk: G. Gaudio

ORD4 Photodetectors & Particle ID



- **Developments** on PMTs, MCP-PMTs, SiPMs, SciFi
- Applications in Ring Imaging Cherenkov Detectors (RICH), Time-of-Flight (ToF), TRD and tracking (SciFi)

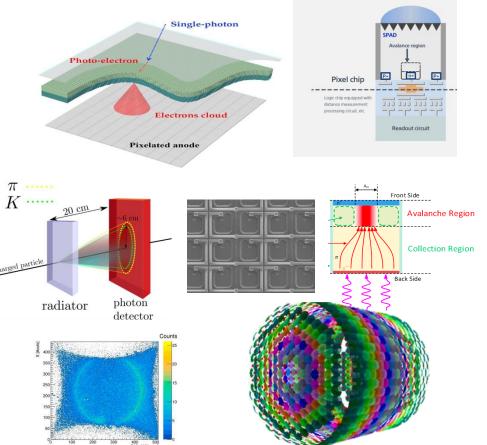
Multi-channel plate PMTs:

- Comsol simulation package
- E.g. Hybrid detector with Medipix4 readout

Silicon Photomultipliers (SiPMs): Array of APD/SPADs

- Many developments, i.e. backside illuminated, integration with CMOS electronics
 - Challenges: improve QE, rad hard, timing, reduce dark count rate
- **Industry interest**: telecommunications, automotive (LIDAR with ToF), with commercial availability (e.g. Broadcom, FBK)

Array of Rich Cells (ARC) concept



Parallel Talk: M. Doser

Quantum & Emerging Technologies



Quantum Technologies are a **rapidly emerging area** of technology development to study fundamental physics

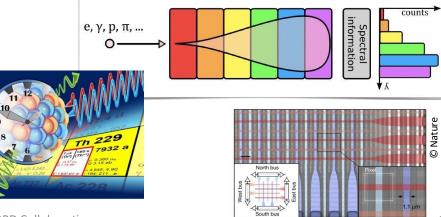
- Targeting Gravitational Waves, Axion, DM detection on shorter-term
- Development of HEP detectors on the longer term

DRD5: different sensors and technologies being investigated:

- Novel materials, kinetic detectors, spin-based, superconducting, optomechanical sensors, atoms/molecules/ions, interferometry, ...
- Scaling up challenge: single \rightarrow multi channels
- HEP-relevant topics: Superconducting nanowires, Chromatic calorimetry
- Many small-scale setups so far. Now first considerations for common infrastructure

Roadmap topics

	Sensor family \rightarrow	clocks	superconduct-	kinetic	atoms / ions /	opto-	nano-engineered
		& clock	ing & spin-	detectors	molecules & atom	mechanical	/ low-dimensional
	Work Package \downarrow	networks	based sensors		interferometry	sensors	/ materials
	WP1 Atomic, Nuclear	Х			X	(X)	
	and Molecular Systems						
	in traps & beams						
~ I	WP2 Quantum		(X)	(X)		X	X
WP'S	Materials (0-, 1-, 2-D)						
\geq	WP3 Quantum super-		X				(X)
	conducting devices						
Proposal	WP4 Scaled-up		X	(X)	X	(X)	X
<u>ຮ</u>	$massive \ ensembles$						
ΧI	(spin-sensitive devices,						
õ	hybrid devices,						
5	mechanical sensors)						
- 1	WP5 Quantum	Х	X	X	X	X	
	Techniques for Sensing						
	WP6 Capacity	Х	X	X	X	X	X
	expansion						

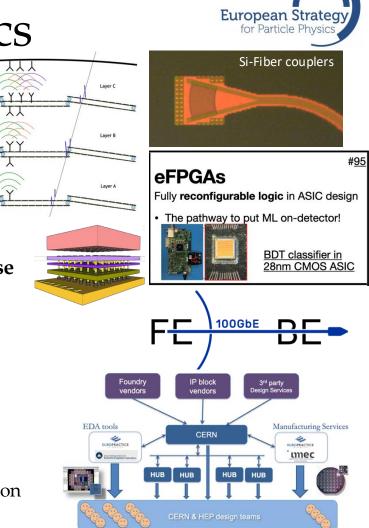


DRD7: Electronics

Electronics is vital to any detector system

Modern technologies offer tremendous opportunities:

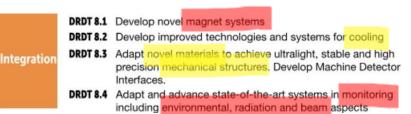
- Transmission speed @100 Gbit/s and beyond
- Extremely high integration density
- Very high-performance FPGAs
- Advanced packaging technologies
- But the complexity and cost associated to their use do also increase
- Work topics in DRD7:
 - Silicon photonics transceivers, power distribution, wireless data transmission and power, interconnections
 - Intelligence on the Front-End: e-FPGA and RISC-V SoC
 - COTS and **no-backend solutions**, i.e. directly from FE to DAQ
 - High Performance ADCs and TDCs and time distribution
 - Extreme environments: cryogenic and radiation-hard electronics
 - Shared access and hubs to selected imaging technologies and 3D integration

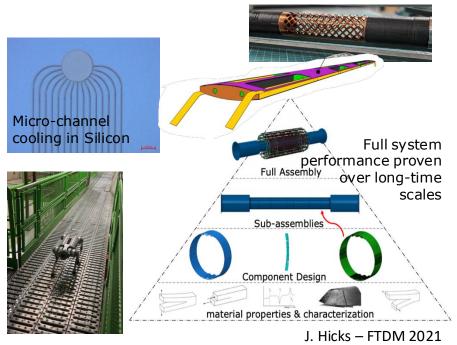




DRD8: Mechanics & Integration

- DRD8 proposal approved by Dec 2024
 - Does not cover all DRDTs, as they are quite diverse
 - Focus on vertex detector mechanics and cooling as emerged from "Forum on Tracker Mechanics" workshop series
- Advanced materials and structures for vertex detectors:
 - Mechanics for curved sensors, Thin beam pipe, Retractable detectors, MDI, Low-mass hardware, alignment
 - Characterization of Material properties and database
- **Cooling**: Airflow, Evaporative CO₂ and new fluids (Krypton), Microchannel cooling in Si, Cooling tubes welding and material investigations
- **Robots** and **Virtual reality** to simulate/remote control access in restricted areas
- **Software** tools to connect engineering design with physics simulation (e.g. connect GEANT4 with CAD)







Where to go from the present DRD collaborations?



Relevant Input proposals

European Strategy for Particle Physics Update 2026

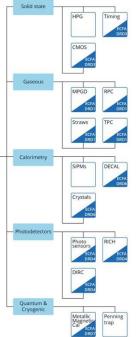


DRD collaborations are often referenced and seen as an already **established concept** in HEP (e.g. in many national submissions)

Neighboring fields:

- Nuclear Physics: large overlap with all DRD collaborations for high-energy NP, referenced in NuPPEC <u>long-range plan 2024</u> in detail; Also e.g. 40% groups in DRD1
- Astroparticle physics: connection with DRD2 and DRD4, Intensifying cooperation suggested (e.g. German astroparticle submission #126,..)

APPEC welcomes the 2021 ECFA detector R&D roadmap for particle physics and acknowledges the synergy with particle physics detector R&D (APPEC Roadmap Update 2023)



Status in the US and Asia



US RDC collaborations:

US HEP community has been engaging broadly in the process on defining and shaping the DRD

- In addition, US Snowmass process recommended creating Detector R&D collaborations (DRCs), organized by <u>CPAD</u>
 - P5 recommends to increase the budget for generic and targeted Detector R&D (#93 (CPAD) and #230 (P5 recommendations)
- Higgs Factory Steering Committee proposes <u>organizational</u> <u>structure</u> for the pre-project detector R&D scope

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Japan: *Instrumentation Technology Development Center* (ITDC) established at KEK in 2023 (input proposal #99)

- promotes semiconductor detectors, scintillators, optical sensors and quantum dots, gas and active media, magnets, Test Beam Line (electrons)
- Belle II (#205), Hyper-K (#238), J-PARC (e.g. #155)

China: Many Chinese groups joined and still join DRD collaborations

• Separate submissions about JUNO (#36), STCF (#231) and CEPC (#153)

RDC#	ΤΟΡΙϹ					
1	Noble Element Detectors					
2	Photodetectors					
3	Solid State Tracking					
4	Readout and ASICs					
5	Trigger and DAQ					
6	Gaseous Detectors					
7	Low-Background Detectors					
8	Quantum and Superconducting Sensors					
9	Calorimetry					
10	Detector Mechanics					
11	Fast Timing					





What is beyond the current DRDs?

• Superconducting Experimental Magnets (initial in TF8)

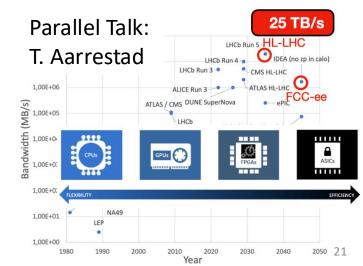
- Al-stabilized Nb-Ti conductor technology used >20 years ago for LHC experiments, worldwide no vendor now, but ALICE3 and ePIC need
- Research aligned with CERN activities, see 2022 workshop and arXiv:2203.07799
- HTS as an alternative with possible synergy to accelerator magnet R&D

• Rare event detectors

- Several submissions (e.g. #112)
- DRD5 would also provide a suitable host for e.g. bolometers
- New TDAQ methods with AI, intelligence on the detector
 - "triggerless" DAQ creates high data rate, throughput challenge (e.g. #127)
 - AI-RDs collaborations proposed as a parallel structure to DRDs (#167)
 - Boundary between electronics (partly covered by DRD7) and computing
- New approach in **microelectronics** (#161)
- Attracting more person power, funding, and engaging new communities (#30, #95, #157,..)



CMS Solenoid 2005



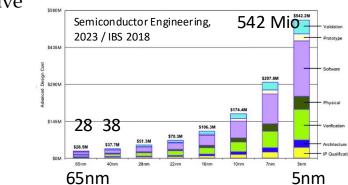
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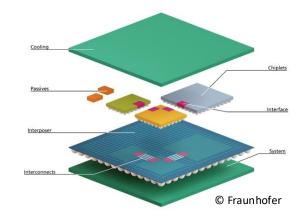
Parallel Talk: F. Simon

Microelectronics Challenge



#161, GSR 2, GSR 5, GSR 9



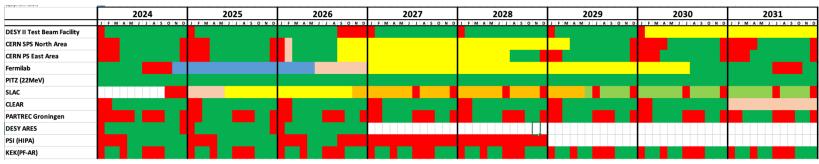


- The **cost and complexity** of developing advanced CMOS technologies have risen dramatically. **HEP is now lagging behind commercial technology**
 - 25 years ago: APV25 (CMS Tracker ASIC) and Pentium-II shared the same technology (250 nm)
 - Supply chain and obsolescence risks: how long is a technology supported?
- Mitigation by **seeking resources beyond HEP** and forming **broader collaborations**, actively encourages cross-disciplinary developments
 - Fewer, common developments with higher volumes
 - Use modern technologies with standardized, common **chiplets** combined to chips tailored to different needs
 - → DRD collaborations can be instrumental by e.g. closer collaboration and developing common chiplet blocks (inter-DRD workshop on electronics needed?)
- Advances in Electronics are also connected to lower power consumption
 - Sustainability topic, less material budget for MAPS vertex detectors

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Infrastructures

- Crucial for further advances in detector instrumentation
 - Most common include test-beam and irradiation facilities
 - But also CERN **neutrino platform**, facilities for **quantum sensor tests**, **magnet tests**, specialized **characterization** setups, **laser** facilities,...
- European projects were instrumental to access irradiation and testbeam facilities and develop them further, e.g. beam telescopes
 - AIDA(-2020)/<u>AIDAinnova</u>, <u>Euro-LABS</u> for TNA
- Accelerator upgrades also affect the interruption of testbeam facilities
 - No testbeam activity during CERN LS3



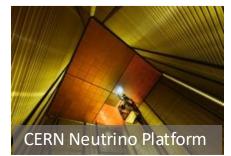


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FNAL #11, DESY #72,

#244, GSR1



https-//cern.ch/international-facilities

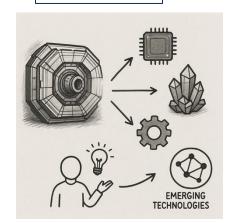
Last Update 23/04/2025	
Running	1
Winter/Summer Shutdown	2
Longer Shutdown	3
Unclear	4
Likely	5
Pending Approval	6
Equipment failure	7

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Partnerships in Engineering

- HEP detectors are electronic detectors with highly specific, "niche" requirements
 - Many technologies critical for HEP do not have a lucrative commercialization path, i.e. radiation hardness
 - Need to identify overlapping topics with mutual interest
- Welcoming expertise from outside the traditional HEP becomes necessary due to increasing complexity, size and large material count of HEP detectors, e.g. in
 - Material science
 - Advanced manufacturing, Mechanics, QA experts
 - Bring in disruptive ideas and technologies, e.g. in quantum sensing
- Involve the industry early in R&D processes and co-develop
 - Connecting with the right company is a challenge, so networking efforts can help, e.g. exploit Alumni networks of former students



#95, #161, GSR2

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M. Demarteau Training, Education and Careers

- Sustainable Career Models: Addressing long-term career paths
 - **Competitive salaries** enable mobility between academia and industry to ensure a stable talent pipeline → Academia cannot compete with industry, thus alternatives necessary
 - Find partnerships and open career paths from closely connected technological domains within academia, i.e. undergraduates electrical/electronics engineering faculties
 - Start with engagement even earlier: Outreach in high schools
- Establishing a European Curriculum in Instrumentation
 - **Beginner level:** through university master's and graduate programs, supported by material compiled by HEP
 - Intermediate level: Erasmus Mundus Master in Instrumentation
 - Advanced level: (PhD and postdoc level): dedicated schools in instrumentation (e.g. EDIT) or DRD-specific schools
 - Establish a CERN-hosted instrumentation school similar to *CERN Accelerator School* and the *CERN School of Computing*







#30, GSR8

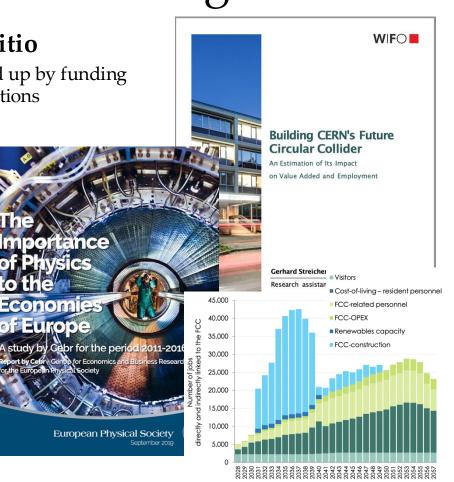
Establish long-term funding

DRD collaborations do not bring funding ab initio

• Only resource-loaded projects described in MoUs will be backed up by funding agencies commitments $\rightarrow 2^{nd}$ phase of setting up DRD collaborations

Funding agencies need to be convinced that detector R&D is a good investment

- Benefit not only for HEP, but also astroparticle and nuclear physics
- **Society at large**: job creation, education, training, applications and KT to other domains, e.g., medical physics (dosimetry, PET, imaging,..), automotive, environmental,...
- No metric exists to quantify socioeconomic impact of instrumentation, but other studies exist
 - Cebr study for EPS (to be updated soon)
 - WIFO report: FCC will generate €50 billion in worldwide value added and create around 26,000 jobs annually



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GSR4

Summary

- Progress in instrumentation allows new discoveries
 - Instrumentation has come a long way from where it started
 - **Must not be the limiting factor for meeting the needs** of the long-term European particle physics, nuclear and astroparticle physics program
 - → on the contrary, **it should be the driver**
- Eight CERN-hosted **Detector R&D (DRD) collaborations** have been set up following ECFA Detector roadmap to work on **strategic** R&D

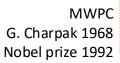


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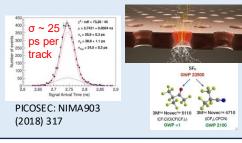




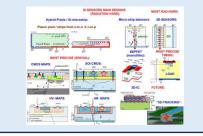
DRD Collaborations



DRD1: Gaseous Detectors Large · Fast · eco-friendly gases · MPGD, e.g. GEMs

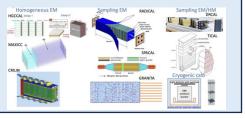


DRD3: Semiconductor Det. Monolithic CMOS · LGADs · radiation hardness · interconns.



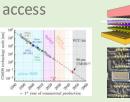
DRD6: Calorimetry

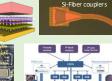
Energy resolution · High granularity · dual readout · particle flow · sandwich · optical



DRD7: Electronics ADC/TDC IP Blocks · Opto-

electronics · packaging · power · extreme environments · COTS · intelligence on detector · foundry

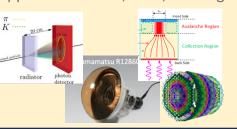




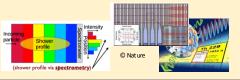
DRD2: Liquid Detectors for Neutrinos · Dark Matter · 0vbb



DRD4: Photon detectors vacuum, solid-state (SiPM), hybrid single-photon and SciFi detectors · applications in PID, RICH, tracking



DRD5: Quantum Sensors Quantum dots · superconduct. nanowires · bolometers · TES · MMC · nuclear clocks Applications in LEPP, first projects in HEPP happening



DRD8: Mechanics

Ultra-thin beam pipes · CF foam and new materials · curved, retractable sensors · air & micro-channel cooling · eco-friendly cooling fluids · robots · augmented reality



Outlook



A healthy environment in detector instrumentation is more than DRD Collaborations:

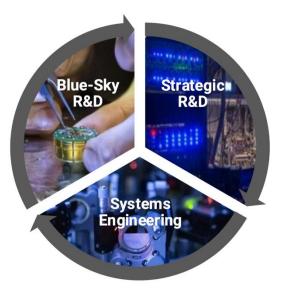
- Blue-sky R&D as an integral part of the R&D portfolio
- Systems engineering to be integrated in R&D efforts

DRD collaborations are still in their infancy

- Evolve on a coherent work program over the next years
- Expected to grow once the LHC Phase-II Upgrades are finished
- Engage with funding agencies to **secure funding** via MoU's

Need to be supported by:

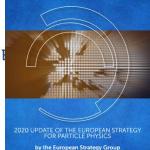
- Excellent lab and test facilities, good career opportunities with training programs, openness for disruptive ideas, strong partnerships and collaborations beyond HEP
 - Many of these statements have been made at the ESPPU 2020 already





Thank you very much for your attention

Last Strategy Update 2020



Brought us decisions for post-HL-LHC times

Concerning instrumentation, it reads (section 4.C):

- The success of particle physics experiments relies on innovative instrumentation and stateof-the-art infrastructures.
- To prepare and realise future experimental research programmes, the community must maintain a strong focus on instrumentation.
- Detector R&D programmes and associated infrastructures should be supported at CERN, national institutes, laboratories and universities.
- Synergies between the needs of different scientific fields and industry should be identified and exploited to boost efficiency in the development process and increase opportunities for more technology transfer, benefiting society at large.
- Collaborative platforms and consortia must be adequately supported to provide coherence in these R&D activities.
- The community should define a global detector R&D roadmap that should be used to support proposals at the European and national levels.

http://dx.doi.org/10.17181/CERN.JSC6.W89E

R&D Topics and DRDTs

Vertex detecto

Tracker

Calori

Time of

- The most urgent R&D topics in each Task Force area are identified by Detector Readiness Matrix
- **Detector R&D Themes (DRDTs)** were formulated as high-level deliverables:

	DRDT 3.1	Achieve full integration of sensing and microelectronics in monolithic
		CMOS pixel sensors
a li d	DRDT 3.2	Develop solid state sensors with 4D-capabilities for tracking and
olid		calorimetry
tate	DRDT 3.3	Extend capabilities of solid state sensors to operate at extreme
		fluences
	DRDT 3.4	Develop full 3D-interconnection technologies for solid state devices
		in particle physics
		Semiconductor Example

• Both were used to define work packages, projects, and deliverables in DRD collaboration proposals

2	DRD	for Particle Physics				
				41.05. 41.05.3 41.05.4 41.08.4 1.09.4 1.09.4	(1891)	
			²⁴ 04 202 641 202 1462 76 1462 76 1202 8 916 11 202 8 916 11 202 8 11 002	41.05. 41.05. 41.05. 41.05. 41.05. 40.05. 40.05. 40.05.		FCC ₁₁ , ^{CCC₆, ^{MuOn}COllog.}
		DRDT	< 2030	2030-2035	2035- 2040 2040-20	5 > 045
	Position precision	3.1,3.4	• • •	•••		
	Low X/X _o	3.1,3.4	• • • • •		••••	
	Low power	3.1,3.4				
	High rates	3.1,3.4				
or ²⁾	Large area wafers ³⁾	3.1,3.4	••••	• •		
	Ultrafast timing ⁴⁾	3.2	•		••••	
	Radiation tolerance NIEL	3.3				
	Radiation tolerance TID	3.3				
	Position precision	3.1,3.4 3.1,3.4				
	Low X/X _o Low power	3.1,3.4		XX X		
	High rates	3.1,3.4		••••		
r ⁵⁾	Large area wafers ³⁾	3.1,3.4				
	Ultrafast timing4)	3.2				
	Radiation tolerance NIEL	3.3				
	Radiation tolerance TID	3.3				
	Position precision	3.1,3.4				
	Low X/X	3.1,3.4				
	Low power	3.1,3.4				
	High rates	3.1,3.4				
meter ⁶⁾	Large area wafers ³⁾	3.1,3.4		•		ŏ b o
	Ultrafast timing4)	3.2				ě í ě
	Radiation tolerance NIEL	3.3				
	Radiation tolerance TID	3.3				•
	Position precision	3.1,3.4	•	• • •	•	
	Low X/X _o	3.1,3.4	•	• • •	• •	
	Low power	3.1,3.4		• • •	• •	
f flight ⁷⁾	High rates	3.1,3.4				
	Large area wafers ³⁾	3.1,3.4		• • •	•	
	Ultrafast timing4)	3.2	•	• • •	• •	
	Radiation tolerance NIEL	3.3		•		
	Radiation tolerance TID	3.3		•		

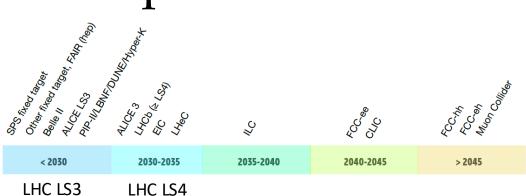
European

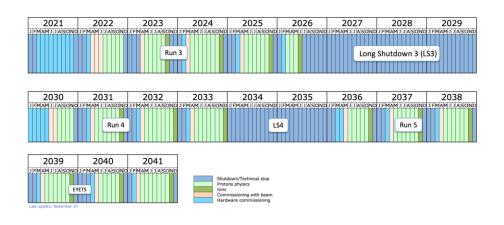


Time Periods and Experiments

- Time periods for "Large experiments"
 - synchronized with LHC schedule
- Time periods for "Smaller Experiments"
 - DM and Neutrino

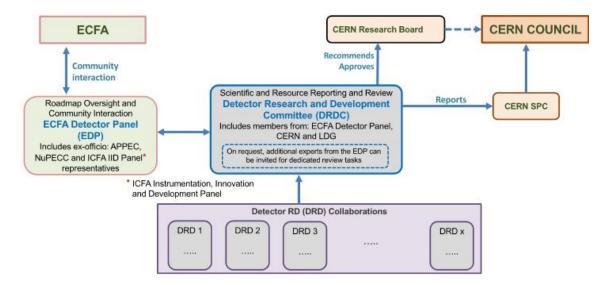






Roadmap implementation plan

- Approved by CERN SPC and Council in fall 2022 (<u>CERN/SPC/1190 ; CERN/3679</u>)
- CERN will host DRD collaborations
 - Interaction between DRD collaborations and committees through DRDC
 - Interface to ECFA via ECFA Detector panel: <u>https://ecfa-dp.desy.de</u>
- Distinction between reviewing body (DRDC) and advising body (EDP)
- EDP also provides input to the next Strategy update



for Particle Phys



DRD Collaboration Sizes

Collab.	Торіс	Number of institutes	Interested people	FTE available	FTE requested	Budget available [kCHF per year]	Budget requested [kCHF per year]
DRD1	Gas det.	165	700+	281	123	3000	2800
DRD3	Solid-state	145	700+	171+156	171	5070	7898
DRD6	calo	135		~180	70/100	3200/1200	1300/2500-3000
DRD2	liquid	86	205	145	315	2500	7000
DRD4	Photo+PID	74		105	60	1600	7000
DRD5	Quantum	112	344	~100			
DRD7	electronics	67		110	69	~2300	~2000
DRD8	mechanics	38		35,3	62,3	1360	3825